

DABiC-5 32-Bit Serial Input Latched Sink Drivers

Last Time Buy

This part is in production but has been determined to be LAST TIME BUY. This classification indicates that the product is obsolete and notice has been given. Sale of this device is currently restricted to existing customer applications. The device should not be purchased for new design applications because of obsolescence in the near future. Samples are no longer available.

Date of status change: November 1, 2010

Deadline for receipt of LAST TIME BUY orders: April 30, 2011

Recommended Substitutions:

For existing customer transition, and for new customers or new applications, contact Allegro Sales.

NOTE: For detailed information on purchasing options, contact your local Allegro field applications engineer or sales representative.

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DABiC-5 32-Bit Serial Input Latched Sink Drivers

Features and Benefits

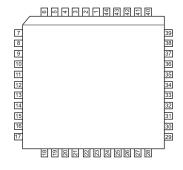
- 3.3 to 5 V logic supply range
- To 10 MHz data input rate
- 30 V minimum output breakdown
- Darlington current-sink outputs
- Low-power CMOS logic and latches
- Schmitt trigger inputs for improved noise immunity

Applications:

- Thermal printheads
- Multiplexed LED displays
- Incandescent lamps

Not to scale

Package: 44-pin PLCC (suffix EP)



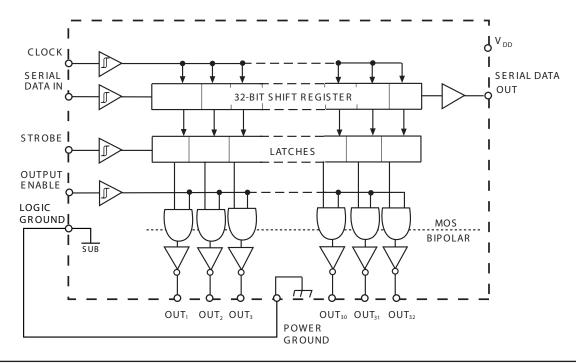
Description

Designed to reduce logic supply current, chip size, and system cost, the A6833 integrated circuit offers high-speed operation for thermal printers. These devices can also be used to drive multiplexed LED displays or incandescent lamps within their 125 mA peak output current rating. The combination of bipolar and MOS technologies gives the A6833 smart power IC an interface flexibility beyond the reach of standard buffers and power driver circuits.

This 32-bit drivers have bipolar open-collector NPN Darlington outputs, a CMOS data latch for each of the drivers, a 32-bit CMOS shift register, and CMOS control circuitry. The high-speed CMOS shift registers and latches allow operation with most microprocessor-based systems. Use of these drivers with TTL may require input pull-up resistors to ensure an input logic high. CMOS serial data outputs permit cascading for applications requiring additional drive lines.

The A6833 is supplied in a 44-lead plastic chip carrier (quad pack), intended for surface mounting on solder lands with 0.050 in. (1.27 mm) centers. These devices are lead (Pb) free, with 100% matte tin plated leadframes.

Functional Block Diagram



A6833

DABiC-5 32-Bit Serial-Input Latched Sink Drivers

Selection Guide

Part Number	Packing	Package 44-nin PLCC					
A6833SEPTR-T	450 pieces per reel	44-pin PLCC					



Absolute Maximum Ratings

Characteristic	Symbol	Notes	Rating	Unit			
Logic Supply Voltage	V _{DD}		7	V			
Input Voltage Range	V _{IN}	Caution: CMOS devices have input-static protection, but are susceptible to damage when exposed to extremely high static-electrical charges.					
Output Voltage	V _{OUT}		30	V			
Continuous Output Current	I _{OUT}	Each output	125	mA			
Output Current Sink	I _{OUT(sink)}		10	mA			
Package Power Dissipation	P _D	Derate linearly to 0 W at 150°C	2.5	W			
Operating Ambient Temperature	T _A	Range S	–20 to 85	°C			
Maximum Junction Temperature	T _J (max)		150	°C			
Storage Temperature	T _{stg}		-55 to 150	°C			



ELECTRICAL CHARACTERISTICS¹ Unless otherwise noted: $T_A = 25$ °C, logic supply operating voltage $V_{dd} = 3.0 \, \text{V}$ to $5.5 \, \text{V}$

			V _{dd} = 3.3 V			'			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Output Leakage Current	I _{CEX}	V _{OUT} = 30 V	-	_	10	-	_	10	μA
Collector–Emitter Saturation	V	I _{OUT} = 50 mA	-	_	0.7	_	_	0.7	V
Voltage	V _{CE(SAT)}	I _{OUT} = 100 mA	-	_	1.0	-	_	1.0	V
Input Voltage	V _{IN(1)}		2.2	_	_	3.3	_	_	V
Imput voltage	V _{IN(0)}		_	_	1.1	_	_	1.7	V
Input Current	I _{IN(1)}	$V_{IN} = V_{DD}$	_	< 0.01	1.0	_	< 0.01	1.0	μΑ
Imput Guirent	I _{IN(0)}	V _{IN} = 0 V	-	<-0.01	-1.0	-	<-0.01	-1.0	μΑ
Serial Data Output Voltage	V _{OUT(1)}	I _{OUT} = -200 μA	2.8	3.05	-	4.5	4.75	_	V
Serial Data Output Voltage	V _{OUT(0)}	I _{OUT} = 200 μA	_	0.15	0.3	_	0.15	0.3	V
Maximum Clock Frequency ²	f _c		10	_	_	10	_	_	MHz
Logic Supply Current	I _{DD(1)}	One output on, I _{OUT} = 100 mA	_	_	2.0	_	_	2.0	mA
Logic Supply Current	I _{DD(0)}	All outputs off	_	_	100	_	_	100	μΑ
Output Enable-to-Output Delay	t _{dis(BQ)}	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	-	_	1.0	_	_	1.0	μs
Output Enable-to-Output Delay	t _{en(BQ)}	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	-	_	1.0	-	_	1.0	μs
Strobe-to-Output Delay	t _{p(STH-QL)}	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	_	_	1.0	_	_	1.0	μs
Strobe-to-Output Delay	t _{p(STH-QH)}	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	_	_	1.0	_	_	1.0	μs
Output Fall Time	t _f	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	-	_	500	_	_	500	ns
Output Rise Time	t _r	V _{CC} = 50 V, R1 = 500 Ω, C1≤30 pF	-	_	500	_	_	500	ns
Clock-to-Serial Data Out Delay	t _{p(CH-SQX)}	I _{OUT} = ±200 μA	_	50	_	_	50	_	ns

¹Positive (negative) current is defined as conventional current going into (coming out of) the specified device pin.

Truth Table

Serial		S	hift	Regi	ister	Cont	ents	Serial			Lat	ch C	Cont	ents		Output	Output Contents					
Data Input	Clock Input		l ₂	l ₃		I _{N-1}	I _N	Data Output	Strobe Input	I ₁	l ₂	I ₃		I _{N-1}	I _N	Enable Input	I ₁	l ₂	I ₃		I _{N-1}	I _N
Н	۲	Η	R_1	R_2		R _{N-2}	R _{N-1}	R _{N-1}														
L	ᅱ	L	R_1	R_2		R _{N-2}	R _{N-1}	R _{N-1}														
Х	L	R ₁	R_2	R ₃		R _{N-1}	R _N	R _N														
		Х	Х	Х		Х	Х	Х	L	R ₁	R ₂	R ₃		R _{N-1}	R _N							
		P ₁	P ₂	P ₃		P _{N-1}	P _N	P_N	Н	P ₁	P ₂	P ₃		P _{N-1}	P_N	Н	P ₁	P ₂	P ₃		P _{N-1}	P _N
										Х	Χ	Χ		Х	Х	L	Н	Н	Н		Н	Н

L = Low Logic Level H = High Logic Level



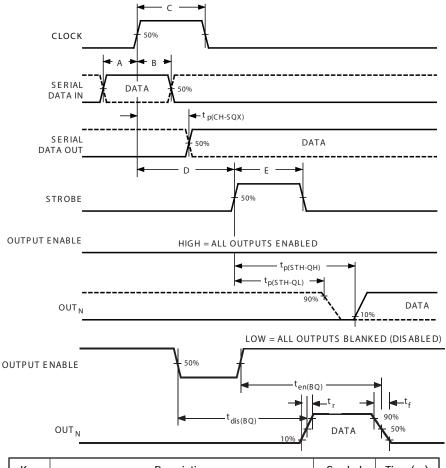
²Operation at a clock frequency greater than the specified minimum value is possible but not warranteed.

P = Present State R = Previous State

X = Irrelevant

Timing Requirements and Specifications

(Logic Levels are V_{DD} and Ground)



Key	Description	Symbol	Time (ns)
Α	Data Active Time Before Clock Pulse (Data Set-Up Time)	t _{su(D)}	25
В	Data Active Time After Clock Pulse (Data Hold Time)	t _{h(D)}	25
С	Clock Pulse Width	t _{w(CH)}	50
D	Time Between Clock Activation and Strobe	t _{su(C)}	100
E	Strobe Pulse Width	t _{w(STH)}	50

NOTE: Timing is representative of a 10 MHz clock. Higher speeds may be attainable; operation at high temperatures will reduce the specified maximum clock frequency.

Serial Data present at the input is transferred to the shift register on the logical 0 to logical 1 transition of the CLOCK input pulse. On succeeding CLOCK pulses, the registers shift data information towards the SERIAL DATA OUTPUT. The SERIAL DATA must appear at the input prior to the rising edge of the CLOCK input waveform. Information present at any register is transferred to the respective

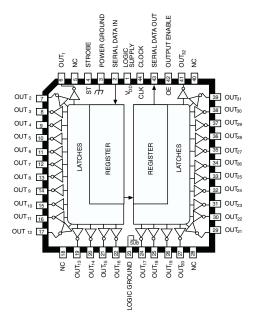
latch when the STROBE is high (serial-to-parallel conversion). The

latches will continue to accept new data as long as the STROBE is held high. Applications where the latches are bypassed (STROBE tied high) will require that the OUTPUT ENABLE input be low during serial data entry.

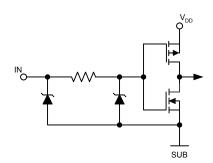
When the OUTPUT ENABLE input is low, the output sink drivers are disabled (OFF). The information stored in the latches is not affected by the OUTPUT ENABLE input. With the OUTPUT ENABLE input high, the outputs are controlled by the state of their respective latches.



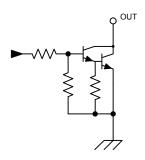
Pin-out Diagram



Typical Input Circuit

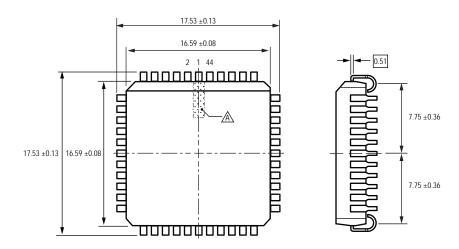


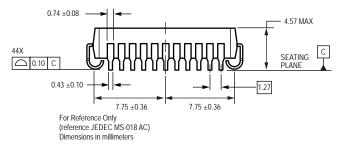
Typical Output Driver





Package EP, 44-pin PLCC





Dimensions exclusive of mold flash, gate burrs, and dambar protrusions Exact case and lead configuration at supplier discretion within limits shown Terminal #1 mark area

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